XLP PIC® MCUs

eXtreme Low Power (XLP)
PIC® Microcontrollers

www.microchip.com/xlp
Microchip’s XLP PIC® MCUs
As more wearable technology, wireless sensor networks and other smart devices are connected to the Internet of Things (IoT), energy conservation becomes paramount. Today’s connected applications must consume little power and, in extreme cases, last for up to 20+ years while running from a single battery. To enable applications like these, products with Microchip’s eXtreme Low Power (XLP) technology offer the industry’s lowest Run and Sleep currents.

Benefits of XLP PIC MCUs

Low Sleep Currents with Flexible Wake-Up Sources
- Sleep current down to 9 nA
- Brown-Out Reset (BOR) down to 45 nA
- Real-time clock down to 300 nA
- Watch-Dog Timer (WDT) down to 200 nA

Battery-Friendly Features
- Enable battery lifetime greater than 20 years
- Low-power supervisors for safer operation (BOR, WDT)
- Core Independent Peripherals (CIPs) take the load off the CPU and perform extremely complex tasks in self-sustaining mode at lowest possible energy requirement

V_{BAT} Battery Back-Up
- Automatic switch-over upon loss of V_{DD}
- Maintains Real-Time Clock/Calendar (RTCC) and user registers
- Powered separately from 1.8–3.6V source (coin cell)

Large Portfolio of XLP MCUs
- 8–121 pins,
  4–256 KB Flash
- Wide selection of packages
- Active mode currents as low as 30 µA/MHz with efficient instruction set with over 90% single-cycle instructions

XLP PIC MCU Application Examples

Internet of Things
- Remote controls
- Security systems
- Portable meters
- Wireless sensors
- Electronic locks
- Asset tracking

Wearables
- Fitness monitors
- Wearable sensors

Smart Energy
- Energy meters
- Flow meters
- Smart plugs
- Energy management

Connected Home
- Bluetooth® Low Energy devices
- Security
- Thermostats
- Smoke detectors

Energy Harvesting
- Solar harvesting
- RF-powered devices

Medical
- Glucometers
- Blood pressure meters
- Patient monitors
- Pulse oximeters
Cloud Connectivity for IoT-Enabled Embedded Systems

The Internet of Things is drastically changing interaction with objects and devices in any location. When you combine XLP PIC® microcontrollers with a variety of wired/wireless technologies from Microchip, you can design an end-to-end solution for the Internet of Things. You can successfully connect your embedded system to the cloud and take advantage of all of its benefits using Microchip’s complementary products such as:

- XLP PIC MCUs which run communication stacks like RF4CE, MiWi™ Wireless Networking Protocol and cloud interface
- zigbee® and IEEE 802.15.4 low-power radio modules
- Certified Wi-Fi®, Bluetooth and Bluetooth Low Energy (BTLE) modules
- LoRa® long-range communication modules

End-to-End Design Solutions for Wearables

Extremely small, wearable devices are popular, either as stand-alone accessories or as companions for use with a smartphone. Wearable technology is being developed for many applications including medical diagnostics, fitness monitoring and personal entertainment. Our MCU portfolio meshes perfectly with the needs of wearable designs, offering:

- Ultra-low power
- Low-profile and small-footprint
  - QFN, uQFN and chip-scale packages
- Secure personal data
  - Integrated hardware cryptography
  - 10x performance with increased energy savings
  - Extensive cryptographic libraries
- Effortless connectivity with Microchip’s complementary wireless portfolio
  - Certified Wi-Fi, Bluetooth/BTLE modules
  - Seamless cloud connectivity

Intelligent Healthcare Device Designs

Medical devices that are intended to be portable or wearable must be designed to consume minimal power and run on a single battery while maintaining a compact form factor. Microchip’s XLP technology offers the industry’s lowest currents for Run and Sleep modes, allowing for maximum battery lifetime and compact product size with features like:

- XLP integrated Analog PIC MCUs
  - 16-bit Delta-Sigma Analog-to-Digital Converter (ADC) and high-speed 10 Msps 12-bit SAR ADC for precision measurements
  - Integrated analog peripherals such as op amp and high-speed comparators for system cost reduction and board space optimization
  - Integrated LCD and USB
- Modern human interfaces with integrated capacitive mTouch® sensing
- Operate from a single cell battery
- Low profile and small footprint
  - QFN, uQFN and chip-scale packages
- Effortless interface with Microchip’s complementary products
  - Sensor fusion hub
  - Certified Wi-Fi, Bluetooth/BTLE modules
  - Seamless cloud connectivity
Versatile Wired and Wireless Connectivity

Communication technologies have been commonplace in homes and industry for many years. Recent trends in applications supporting cloud computing, the Internet of Things and smart grid initiatives have created a renewed demand for standardized, low-power communication technology. Whether you are considering adding wired or wireless connectivity to your application, Microchip’s XLP PIC microcontrollers support a wide variety of communication, offering:

- XLP PIC MCUs with integrated USB device, host and OTG
- Free software libraries for communication protocols:
  - USB
  - Bluetooth and Wi-Fi communication
  - IEEE 802.15.4-based ZigBee and MiWi protocols
- Support for LoRa long-range communication
- Pair any XLP MCU with the MCP2200 USB to UART Serial Converter
- Extend battery life for products with USB for data upload/download

Robust Thermal Management

As the Internet of Things continues to evolve, it is likely that the thermostat will play a central role in managing appliances and sensors throughout the home. The XLP PIC microcontroller-based Connected Home Console can serve as a starting point for your smart thermostat or home automation control, leveraging features like:

- XLP PIC MCUs with integrated LCD driver for rich information displays
- Effortless integration with low-power wireless modules for IoT connectivity
- Large-memory LCD MCUs supporting RF communication stacks
- Modern human interfaces with capacitive mTouch sensing
- Single cell battery operation
- Complementary range of temperature sensors

Smart Energy and Smart Grid

As the demand and cost for energy continue to increase, there is a focus on improving energy efficiency, leading to new smart grid and smart energy solutions. The goal is to improve energy distribution management and energy utilization and prevent tampering. Microchip offers innovative XLP PIC microcontrollers for smart grid, smart metering and utility communication systems design. Key features include:

- Industry’s leading XLP low-power modes for energy-efficient designs
- XLP integrated Analog PIC MCUs
  - Dual-channel 16-bit Delta-Sigma ADC for precision measurements
  - Integrated LCD and USB for external interface
- Modern human interfaces with integrated capacitive mTouch sensing
- Effortless connectivity with
  - Wired Ethernet
  - Bluetooth
  - IEEE 802.15.4 with ZigBee and MiWi protocols
  - Wi-Fi communication
  - LoRa long-range communication
Microchip’s Low-Power Solutions

Safety and Security for IoT-Enabled Designs
Embedded applications in the Internet-connected world demand secure data and long battery life. Microchip’s XLP PIC microcontrollers ensure data integrity without sacrificing power consumption through an integrated hardware crypto engine. These MCUs offer unique key creation and secure key storage for applications such as IoT sensor nodes and access control systems with features like:

- Integrated hardware cryptography
  - AES256, DES, 3DES cryptography, secure RAM, OTP for key management
  - True random number generator for key generation, auto key destruct on tamper detect
- Integrated LCD and USB for external interface
- Human interfaces with capacitive mTouch sensing
- Free communication protocol stacks
- Seamless integrated with certified Wi-Fi, Bluetooth/BTLE modules, zigbee and IEEE 802.15.4 low-power radio modules for IoT connectivity

8- and 16-bit Low-Power Energy Harvesting
Microchip’s XLP PIC microcontrollers with the industry’s leading low-power modes enable energy harvesting, battery-free and power-constrained applications with features such as:

- Ultra-low power consumption
  - Sleep currents as low as 9 nA
  - Brown-out reset down to 45 nA
  - Watch-dog timer down to 200 nA
  - Real-time clock/calendar down to 300 nA
  - Run currents down to 30 µA/MHz
- Flexible low-power modes based on application needs
  - Idle mode, Sleep mode, Deep-Sleep modes
  - Low-power retention sleep mode
- Effortless integration with wireless 802.15.4 RF connectivity
  - 2.4 GHz
  - Sub-GHz
- Ideal for applications with:
  - RF sensors
  - Temperature sensors
  - Remote controls
  - Security sensors

Low-Power Peripheral Integration
XLP PIC microcontrollers with low-power Core Independent Peripherals (CIPs) and other highly integrated peripherals, enable low-cost solutions that require reduced energy and development time. Low-power peripherals like LCD, op amp, Real-Time Clock/Calendar (RTCC), mTouch sensing, USB, DMA, cryptography and additional CIPs take MCU performance to a new level with the least possible power consumption. With a number of on-board modules designed to increase the capability of the system, these XLP MCUs offer the best value in embedded design.

Low-Power, CPU-Free Performance – Low-power peripherals are smartly interconnected to allow nearly zero latency in the sharing of data, logic inputs or analog signals without additional code or interruption of the CPU. Since this frees the CPU to perform other system tasks and reduces Flash memory consumption, the CPU can be put into low-power states consuming minimal energy, while the peripherals perform necessary functions. This significantly reduces energy consumption by MCU.

Significant Savings – By taking the load off the CPU, low-power peripherals allow the MCU to perform extremely complex tasks, such as cryptography and communication, thus allowing the CPU to perform additional tasks and eliminating the need to migrate to a complex and expensive system. Additionally, significant BOM cost savings can be realized by replacing off-board discrete components with these integrated peripherals.
XLP MCU Portfolio

With many pin, memory and peripheral combinations available, Microchip’s XLP products have the right combination of features for your low power application. The product families below include some key XLP PIC MCUs. For a complete list of XLP MCUs, datasheets and other references please visit the XLP Design Center at www.microchip.com/xlp.

<table>
<thead>
<tr>
<th>Device</th>
<th>Flash Memory (KB)</th>
<th>Pins</th>
<th>Sleep (nA)</th>
<th>WDT (nA)</th>
<th>RTCC (nA)</th>
<th>1 MHz Run (µA)</th>
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<tbody>
<tr>
<td>PIC18F “K42”</td>
<td>16–128</td>
<td>28–48</td>
<td>60</td>
<td>720</td>
<td>–</td>
<td>45</td>
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<tr>
<td>PIC16F153xx</td>
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<td>8–48</td>
<td>50</td>
<td>500</td>
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<tr>
<td>PIC16F188xx</td>
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<td>28–40</td>
<td>50</td>
<td>500</td>
<td>–</td>
<td>32</td>
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<tr>
<td>PIC16F191xx</td>
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<td>50</td>
<td>500</td>
<td>400</td>
<td>32</td>
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<tr>
<td>PIC18F “K40”</td>
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<td>28–64</td>
<td>50</td>
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<td>170</td>
<td>155</td>
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</tbody>
</table>

Complementary Analog, Interface and Connectivity Products

Microchip offers a wide portfolio of complementary Analog, interface and connectivity products that can be used in developing low-power applications. The portfolio meets today’s demanding design requirements addressing linear, mixed-signal, power management, thermal, interface and connectivity products. When combined with XLP microcontrollers, these devices enable low-power designs in consumer, medical and IoT applications. Microchip’s complementary Analog, interface and connectivity products includes:

- **Linear**
  - Amplifiers
  - Comparators
- **Wireless**
  - Wi-Fi modules and antennas
  - Bluetooth modules
  - Bluetooth silicon
  - LoRa, zigbee and MiWi protocol solutions
- **Power management**
  - DC/DC converters
  - Battery chargers
  - System supervisors/voltage detectors
- **Safety and security**
  - Smoke detector ICs
  - Piezoelectric horn drivers
- **Thermal management**
  - Temperature sensors
- **Timing**
  - Oscillators
- **Mixed signal**
  - Power monitoring and metering
  - 8/10/12-bit ADCs
  - Digital potentiometers
  - Power measurement ICs
  - Voltage references

References

XLP Battery Life Estimator (Free Download)

The XLP Battery Life Estimator is a free software utility that aids in developing low-power applications with Microchip’s PIC MCUs with XLP technology.

- **Easy to use**
  - Select your PIC MCU with XLP technology and your battery type
  - Enter application Run and Sleep times
  - Select peripherals and input application currents
  - View battery life, average and maximum current estimates
- **Flexible**
  - customizable to allow added device profiles and battery specifications
  - Save profiles and compare results

Application Notes

- **AN1861**: Bluetooth Smart Communication Using Microchip’s RN4020 Module and 16-bit PIC MCU
- **AN1556**: Blood Pressure Meter Design Using Microchip’s PIC24F Microcontroller and Analog Devices
- **AN1416**: Low Power Design Guide: A Single Source for Low Power Consumption from the Viewpoint of the MCU
- **AN1267**: XLP Technology: An Introduction to Microchip’s Low-Power Devices
### Featured Development Tools

**8-bit Curiosity Development Board (DM164137)**
This board is a cost-effective, fully integrated 8-bit development platform targeted at first-time users, makers and those seeking a feature-rich, rapid prototyping board with easy IoT connectivity.

- Integrated programmer/debugger
- One mikroBUS™ interface supporting click boards™

**8-bit Curiosity High Pin Count (HPC) Development Board (DM164136)**
This board is a perfect platform to harness the power of modern 8-bit PIC MCUs. Its layout and external connections offer unparalleled access to the Core Independent Peripherals (CIPs).

- Integrated programmer/debugger with USB interface and two mikroBUS interfaces supporting click boards
- Various user interface options: analog potentiometer and physical switches

**PIC24F Curiosity Development Board (DM240004)**
This board features the PIC24FJ128GA204 XLP device with 128 KB Flash and a rich set of peripherals to evaluate the PIC24F XLP MCUs.

- Integrated programmer/debugger with USB interface
- Analog potentiometer, multiple user LEDs, RGB LED and switches
- mikroBUS interface supporting click boards and BM71 Bluetooth LE module footprint

**Explorer 16/32 Development Board (DM240001-2)**
This board supports PIC24F XLP microcontrollers and provides the perfect platform to prototype applications using several expansion possibilities through its wide ecosystem support.

- 100-pin plug-in module socket
- Integrated programmer/debugger with USB interface
- Two mikroBUS interfaces supporting click boards and a PICtail™ Plus interface

**Explorer 8 Development Kit (DM160228)**
Supporting the largest number of 8-bit PIC MCUs ranging from 6 to 100 pins, the Explorer 8 Development Kit is a rapid proof-of-concept tool with extensive integration for optimized "out-of-box" experience.

- Two Pmod™ interfaces supporting Digilent Pmods
- Two mikroBUS interfaces supporting click boards

**LCD Explorer XLP Development Board (DM240314)**
This board enables development with the 16-bit family of PIC XLP MCUs in 100 pins.

- Flexible power options
- 96 segments LCD display, LEDs, buttons and mTouch cap button
- PICtail Plus connector

**MPLAB® Starter Kit for PIC24F Intelligent Integrated Analog (DM240015)**
This kit features the PIC24F “GC” family with advanced integrated analog that reduces BOM cost, lowers noise and has faster throughput.

- Analog header for clean analog signal access and integrity as well as an on-board debugger/programmer
- On-board sensors such as light sensor, potentiometer, microphone and temperature
- Custom LCD features a 296 dot-matrix array for text display and 17 special icons
Support
Microchip is committed to supporting its customers in developing products faster and more efficiently. We maintain a worldwide network of field applications engineers and technical support ready to provide product and system assistance. For more information, please visit www.microchip.com:
- Technical Support: www.microchip.com/support
- Evaluation samples of any Microchip device: www.microchip.com/sample
- Knowledge base and peer help: www.microchip.com/forums
- Sales and Global Distribution: www.microchip.com/sales

Training
If additional training interests you, Microchip offers several resources including in-depth technical training and reference material, self-paced tutorials and significant online resources.
- Overview of Technical Training Resources: www.microchip.com/training
- MASTERS Conferences: www.microchip.com/masters
- Developer Help Website: www.microchip.com/developerhelp
- Technical Training Centers: www.microchip.com/seminars